

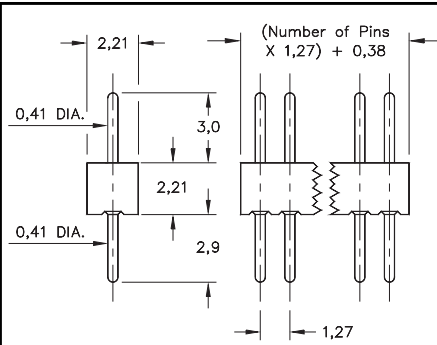


Fig. 1

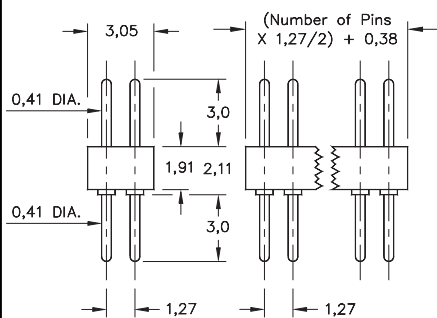


Fig. 2

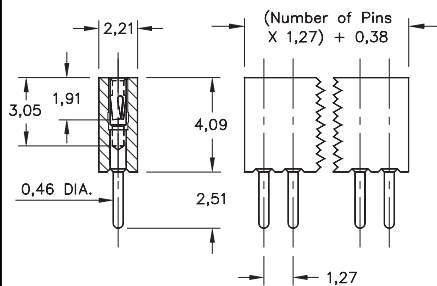


Fig. 3

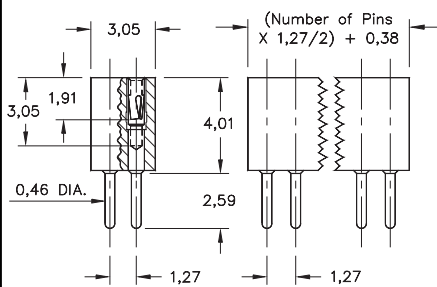


Fig. 4

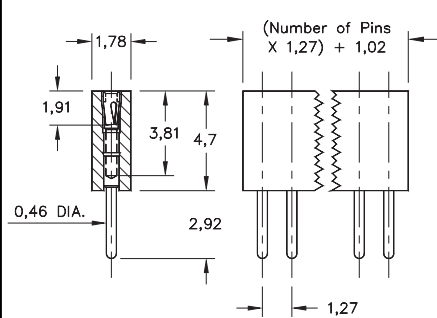
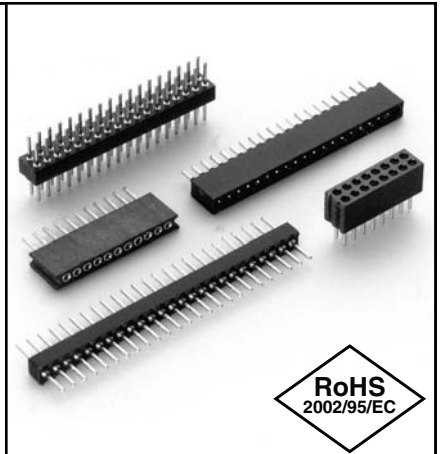


Fig. 5

- Series 850 single and double row interconnects have 1,27 pin spacing & permit board stacking as low as 6,3.
- Pin headers have 0,41 dia. pins (MM #4006-0). See page 175 for details.
- MM #0467 and MM #4890 receptacles use Hi-Rel, 3-finger BeCu #11 contacts rated at 3 amps. (#11 contact accepts pin diameters from 0,38 - 0,51). See pages 129 and 131 for details.
- Insulators are high temp. thermoplastic, suitable for all soldering operations.



Ordering Information

Fig. 1	Single Row	2,21 Profile Pin Header			
	850-XX-0__-10-001000 Specify # of pins  01-50				
Fig. 2	Double Row	1,91 Profile Pin Header			
	852-XX-__-10-001000 Specify # of pins  002-100				
For Electrical, Mechanical & Environmental Data, See pg. 4  XX=Plating Code See Below For RoHS compliance select  plating code.					
SPECIFY PLATING CODE XX=		10 	90	40 	
Pin Plating 		0,25µm Au	5,08µm Sn/Pb	5,08µm Sn	
Fig. 3	Single Row	4,09 Profile Socket			
	851-XX-0__-10-001000 Specify # of pins  01-50				
Fig. 4	Double Row	4,09 Profile Socket			
	853-XX-__-10-001000 Specify # of pins  002-100				
Fig. 5	Single Row	4,7 Profile Socket			
	851-XX-0__-10-002000 Specify # of pins  01-77				
For Electrical, Mechanical & Environmental Data, See pg. 4  XX=Plating Code See Below For RoHS compliance select  plating code.					
SPECIFY PLATING CODE XX=			93	99	43 
Sleeve (Pin) 			5,08µm Sn/Pb	5,08µm Sn/Pb	5,08µm Sn
Contact (Clip) 			0,76µm Au	5,08µm Sn/Pb	0,76µm Au